

Features and Benefits

- Current mode PWM control
- Brown-In and Brown-Out function: auto-restart, prevents excess input current and heat rise at low input voltage
- Auto Standby function: improves efficiency by Burst mode operation in light load
- Normal load operation: PWM mode
- Light load operation: Burst mode
- No load power consumption < 25 mW
- Operating frequency, $f_{OSC(AVG)}(typ) = 100 \text{ kHz}$
- Random Switching function: reduces EMI noise, and simplifies EMI filters
- Slope Compensation function: avoids subharmonic oscillation
- Leading Edge Blanking function

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Package: DIP8 Not to scale

Description

The STR-A6059H, STR-A6061H, STR-A6062H, and STR-A6069H are power ICs for switching power supplies, incorporating a power MOSFET and a current mode PWM controller IC in one package.

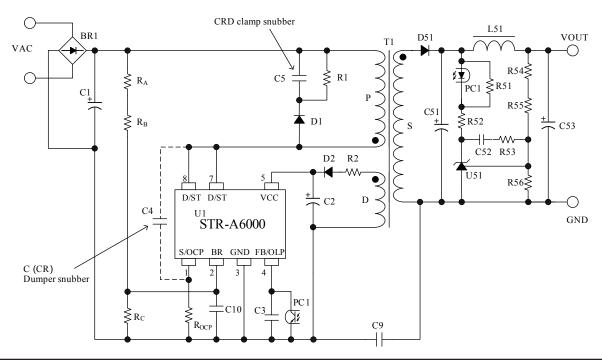
To achieve low power consumption, these products include a startup circuit and a standby function in the controller. The switching modes are automatically changed according to load conditions: in normal operation, PWM mode, and in light load conditions, burst mode. The rich set of protection features helps to realize low component counts, and high performance-to-cost power supply.

Applications:

Switching power supplies for electronic devices such as:

- · Battery charger
- Standby power supply
- Small switch-mode power supply (SMPS)
- Auxiliary power supply for controller

Typical Application Circuit



PWM Off-Line Switching Regulator ICs

Features and Benefits (continued)

- Audible Noise Suppression function during Standby mode
- Protection features
- Overcurrent protection (OCP): pulse-by-pulse, with input compensation function
- ^a Overvoltage protection (OVP): latched shutdown
- Overload protection (OLP): auto-restart, with timer
- ^a Thermal shutdown protection (TSD): latched shutdown

Selection Guide

Coloction Cala	ī .						
Part Number	Power	MOSFET	Output Power*, P _{OUT} (W)				
	\/ (maim)	D (max)	Open	Frame	Adaptor		
	V _{DSS} (min) (V)	$R_{DS(ON)}(max)$ (Ω)	230 VAC	85 to 265 VAC	230 VAC	85 to 265 VAC	
STR-A6059H	650	6	30	19	17	11	
STR-A6069H	700	6	30	19	17	11	
STR-A6061H	700	3.95	35	24	21	15	
STR-A6062H	700	2.8	38	26	23	18	

^{*}The listed output power is based on the thermal ratings, and the peak output power can be 120% to 140% of the value stated here. At low output voltage and short duty cycle, the output power may be less than the value stated here.

The polarity value for current specifies a sink as "+," and a source as "-," referencing the IC.

Absolute Maximum Ratings Unless otherwise specified, T_A = 25°C

Characteristic	Symbol	Notes		Pins	Rating	Unit
	I _{DPEAK}	STR-A6059H STR-A6069H		8 – 1	1.8	А
Drain Peak Current ¹		STR-A6061H	Single pulse		2.5	А
		STR-A6062H			3.0	А
	E _{AS}	STR-A6059H STR-A6069H] - 3 - 1 ,		24	mJ
Avalanche Energy ²		STR-A6061H	Single pulse, V_{DD} = 99 V, L = 20 mH, I_{LPEAK} = 2 A	8 – 1	46	mJ
		STR-A6062H	Single pulse, V_{DD} = 99 V, L = 20 mH, I_{LPEAK} = 2.2 A		56	mJ
S/OCP Pin Voltage	V _{OCP}			1 – 3	−2 to 6	V
Control Part Input Voltage	V _{CC}			5 – 3	32	V
FB/OLP Pin Voltage	V _{FB}			4 - 3	-0.3 to 14	V
FB/OLP Pin Sink Current	I _{FB}			4 - 3	1.0	mA
BR Pin Voltage	V _{BR}			2 - 3	-0.3 to 7	V
BR Pin Sink Current	I _{BR}			2 - 3	1.0	mA
Power Dissipation of MOSFET ³	P _{D1}	Mounted on 1	5mm×15 mm printed circuit board	8 – 1	1.35	W
Power Dissipation of Control Part	P _{D2}			5 - 3	1.2	W
Operating Ambient Temperature ⁴	T _{OP}			-	-20 to 125	°C
Storage Temperature	T _{stg}			-	-40 to 125	°C
Channel Temperature	T _{ch}			_	150	°C

¹Refer to MOSFET Safe Operating Area Curve.

²Refer to MOSFET Avalanche Energy Derating Coefficient Curve.

³Refer to MOSFET Temperature versus Power Dissipation Curve.

 $^{^4}$ The recommended internal frame temperature, T_F , is 115°C (max).

PWM Off-Line Switching Regulator ICs

Electrical Characteristics of Control Part Unless otherwise specified, $T_A = 25$ °C, $V_{CC} = 18$ V

Operation Start Voltage							Unit
	V _{CC(ON)}		5 - 3	13.8	15.3	16.8	V
Operation Stop Voltage ¹	V _{CC(OFF)}		5 - 3	7.3	8.1	8.9	V
Circuit Current in Operation	I _{CC(ON)}	V _{CC} = 12 V	5 - 3	_	_	2.5	mA
Minimum Start Voltage	V _{ST(ON)}		5 - 3	_	38	_	V
Startup Current	I _{STARTUP}	V _{CC} = 13.5 V	5 - 3	-3.7	-2.5	-1.5	mA
Startup Current Threshold Biasing Voltage ¹	V _{CC(BIAS)}	I _{CC} = -100 μA	5 - 3	8.5	9.5	10.5	V
Average Operation Frequency	f _{OSC(AVG)}		8 - 3	90	100	110	kHz
Frequency Modulation Deviation	Δf		8 - 3	_	8	_	kHz
Maximum Duty Cycle	D _{MAX}		8 - 3	77	83	89	%
Minimum On-Time	t _{ON(MIN)}		_	_	470	_	ns
Leading Edge Blanking Time	t _{BW}		_	_	280	_	ns
OCP Compensation Coefficient	DPC		-	-	33	_	mV/µs
OCP Compensation Duty Cycle Limit	D _{DPC}		_	_	36	_	%
OCP Threshold Voltage at Zero Duty Cycle	V _{OCP(L)}		1 - 3	0.70	0.78	0.86	V
OCP Threshold Voltage at 36% Duty Cycle	V _{OCP(H)}	V _{CC} = 32 V	1 - 3	0.81	0.9	0.99	V
Maximum Feedback Current	I _{FB(MAX)}	V _{CC} = 12 V	4 - 3	-340	-230	-150	μA
Minimum Feedback Current	I _{FB(MIN)}		4 - 3	-30	-15	-7	μA
FB/OLP Pin Oscillation Stop Threshold Voltage	V _{FB(STB)}		4 - 3	0.85	0.95	1.05	V
OLP Threshold Voltage	V _{FB(OLP)}		4 - 3	7.3	8.1	8.9	V
OLP Delay Time	t _{OLP}		4 - 3	54	68	82	ms
OLP Operation Current	I _{CC(OLP)}	V _{CC} = 12 V	5 - 3	_	300	600	μA
FB/OLP Pin Clamp Voltage	V _{FB(CLAMP)}		4 - 3	11	12.8	14	V
Brown-In Threshold Voltage	V _{BR(IN)}	V _{CC} = 32 V	2 - 3	5.2	5.6	6	V
Brown-Out Threshold Voltage	V _{BR(OUT)}	V _{CC} = 32 V	2 - 3	4.45	4.8	5.15	V
BR Pin Clamp Voltage	V _{BR(CLAMP)}	V _{CC} = 32 V	2 - 3	6	6.4	7	V
BR Function Disabling Threshold Voltage	V _{BR(DIS)}	V _{CC} = 32 V	2 - 3	0.3	0.48	0.7	V
VCC Pin OVP Threshold Voltage	V _{CC(OVP)}		5 - 3	26	29	32	V
Latch Circuits Holding Current ²	I _{CC(LATCH)}	V _{CC} = 9.5 V	5 - 3	_	700	_	μA
Thermal Shutdown Temperature	T _{j(TSD)}		_	135	_	_	°C

 $^{^{1}}V_{CC(BIAS)} > V_{CC(OFF)}$ always.

²A latch circuit is a circuit operated with Overvoltage Protection (OVP) and/or Thermal Shutdown Protection (TSD) in operation.

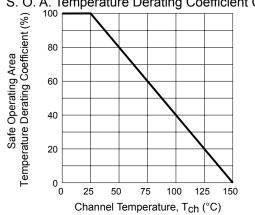
PWM Off-Line Switching Regulator ICs

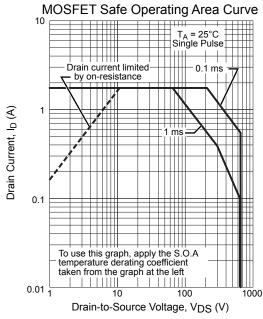
Electrical Characteristics of MOSFET Unless otherwise specified, T_A is 25°C

Characteristic	Symbol	Test (Conditions	Pins	Min.	Тур.	Max.	Unit
		STR-A6059H		8 – 1	650	_	_	V
Drain-to-Source Breakdown Voltage	V _{DSS}	STR-A6061H STR-A6062H STR-A6069H			700	_	_	V
Drain Leakage Current	I _{DSS}			8 – 1	_	_	300	μΑ
		STR-A6059H STR-A6069H			-	-	6	Ω
On-Resistance	R _{DS(ON)}	STR-A6061H		8 – 1	_	_	3.95	Ω
		STR-A6062H			_	_	2.8	Ω
Switching Time	t _f			8 – 1	_	_	250	ns
Thermal Resistance	R _{ech-C}	The thermal resistance between the channels of the MOSFET and the case. Case temperature, T _C , is measured at the center of the case top surface.		_	-	-	22	°C/W

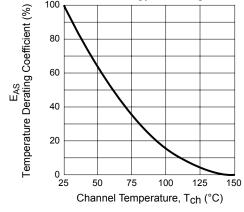
Characteristic Performance STR-A6059H

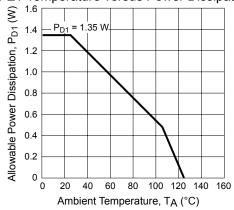
S. O. A. Temperature Derating Coefficient Curve

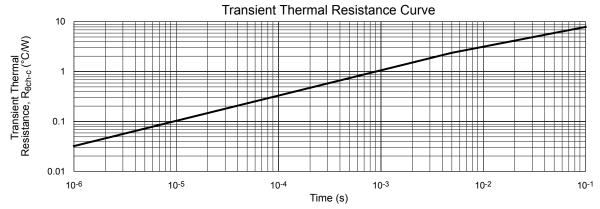




MOSFET Avalanche Energy Derating Coefficient Curve

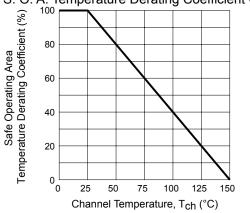


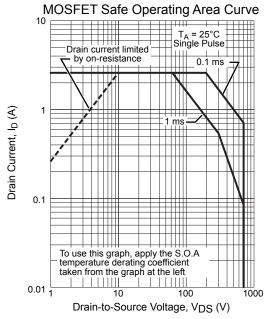




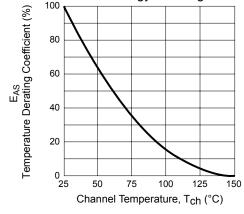
Characteristic Performance STR-A6061H

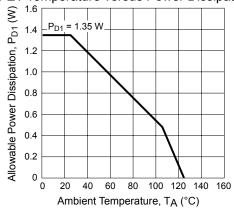
S. O. A. Temperature Derating Coefficient Curve

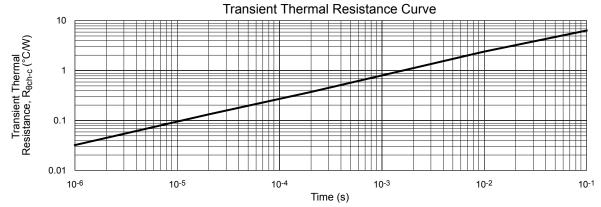




MOSFET Avalanche Energy Derating Coefficient Curve

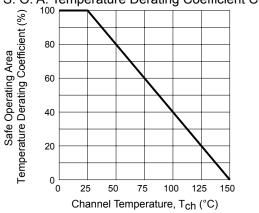


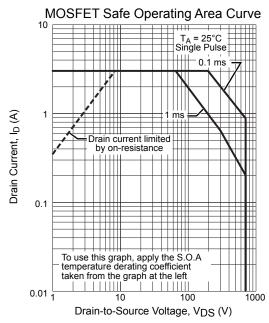




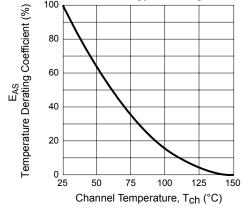
Characteristic Performance STR-A6062H

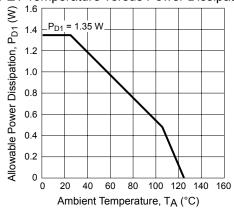
S. O. A. Temperature Derating Coefficient Curve

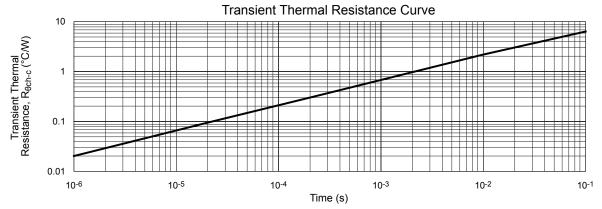




MOSFET Avalanche Energy Derating Coefficient Curve

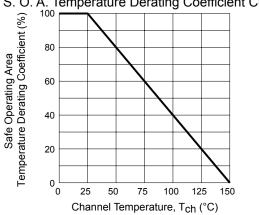


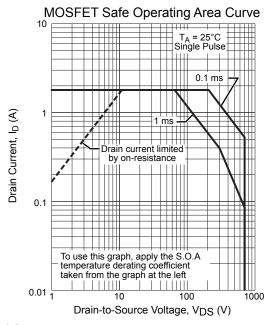




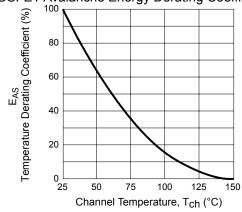
Characteristic Performance STR-A6069H

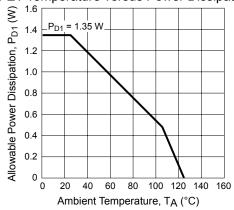
S. O. A. Temperature Derating Coefficient Curve

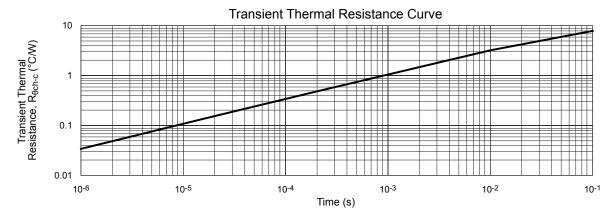




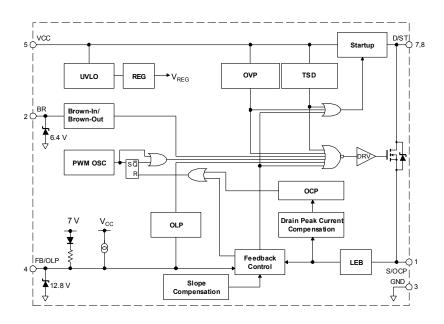
MOSFET Avalanche Energy Derating Coefficient Curve



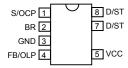




Functional Block Diagram



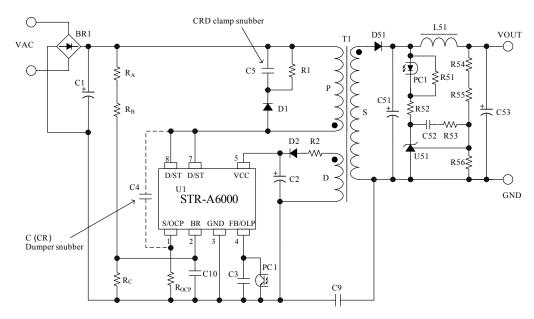
Pin-out Diagram



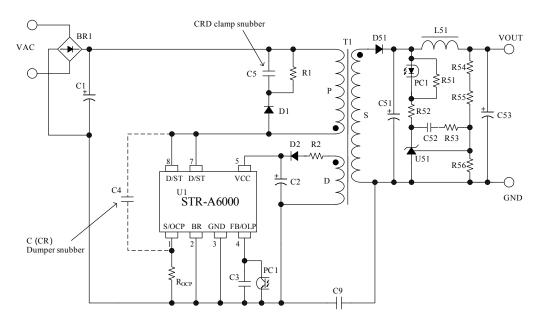
Pin List Table

Number	Name	Function
1	S/OCP	MOSFET source, and input for Overcurrent Protection (OCP) signal
2	BR	Input for Brown-In and Brown-Out detection voltage
3	GND	Ground
4	FB/OLP	Feedback signal input for constant voltage control signal, and input of Overload Protection (OLP) signal
5	VCC	Power supply voltage input for Control Part and input of Overvoltage Protection (OVP) signal
6	_	(Pin removed)
7, 8	D/ST	MOSFET drain, and input of the startup current

Typical Application Circuits



Typical application circuit example, enabled Brown-In/Brown-Out function (DC line detection)

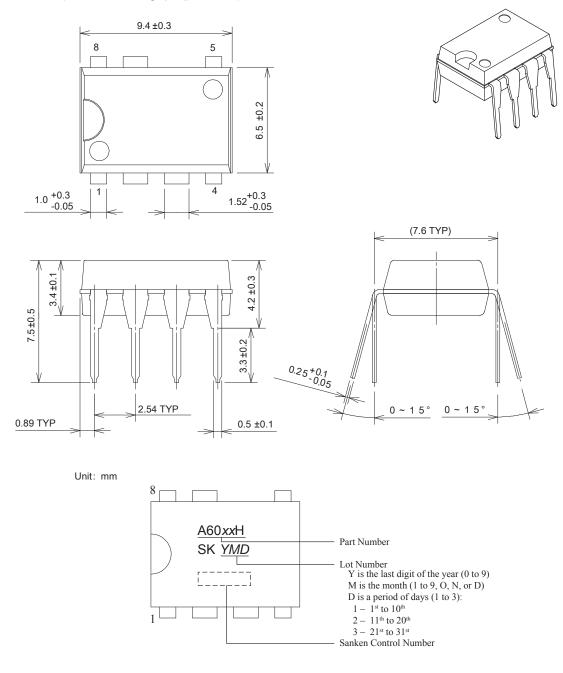


Typical application circuit example, disabled Brown-In/Brown-Out function

PWM Off-Line Switching Regulator ICs

Package Diagram

- DIP8 package
- The following show a representative type of DIP8.
- The pin 6 is removed to provide greater creepage and clearance isolation between the high voltage pins (pins 7 and 8: D/ST) and the low voltage pin (pin 5: VCC).





Device composition compliant with the RoHS directive.

PWM Off-Line Switching Regulator ICs

Operating Precautions

In the case that you use Sanken products or design your products by using Sanken products, the reliability largely depends on the degree of derating to be made to the rated values. Derating may be interpreted as a case that an operation range is set by derating the load from each rated value or surge voltage or noise is considered for derating in order to assure or improve the reliability. In general, derating factors include electric stresses such as electric voltage, electric current, electric power etc., environmental stresses such as ambient temperature, humidity etc. and thermal stress caused due to self-heating of semiconductor products. For these stresses, instantaneous values, maximum values and minimum values must be taken into consideration. In addition, it should be noted that since power devices or IC's including power devices have large self-heating value, the degree of derating of junction temperature affects the reliability significantly.

Because reliability can be affected adversely by improper storage environments and handling methods, please observe the following cautions.

Cautions for Storage

- Ensure that storage conditions comply with the standard temperature (5 to 35°C) and the standard relative humidity (around 40 to 75%); avoid storage locations that experience extreme changes in temperature or humidity.
- Avoid locations where dust or harmful gases are present and avoid direct sunlight.
- Reinspect for rust on leads and solderability of the products that have been stored for a long time.

Cautions for Testing and Handling

When tests are carried out during inspection testing and other standard test periods, protect the products from power surges from the testing device, shorts between the product pins, and wrong connections. Ensure all test parameters are within the ratings specified by Sanken for the products.

Remarks About Using Silicone Grease with a Heatsink

• When silicone grease is used in mounting the products on a heatsink, it shall be applied evenly and thinly. If more silicone grease than required is applied, it may produce excess stress.

• Volatile-type silicone greases may crack after long periods of time, resulting in reduced heat radiation effect. Silicone greases with low consistency (hard grease) may cause cracks in the mold resin when screwing the products to a heatsink.

Our recommended silicone greases for heat radiation purposes, which will not cause any adverse effect on the product life, are indicated below:

Type	Suppliers
G746	Shin-Etsu Chemical Co., Ltd.
YG6260	Momentive Performance Materials Inc.
SC102	Dow Corning Toray Co., Ltd.

Soldering

• When soldering the products, please be sure to minimize the working time, within the following limits:

260 ± 5 °C	10 ± 1 s (Flow, 2 times)
$380 \pm 10 ^{\circ}\text{C}$	3.5 ± 0.5 s (Soldering iron, 1 time)

• Soldering should be at a distance of at least 1.5 mm from the body of the products.

Electrostatic Discharge

- When handling the products, the operator must be grounded. Grounded wrist straps worn should have at least $1M\Omega$ of resistance from the operator to ground to prevent shock hazard, and it should be placed near the operator.
- Workbenches where the products are handled should be grounded and be provided with conductive table and floor mats.
- When using measuring equipment such as a curve tracer, the equipment should be grounded.
- When soldering the products, the head of soldering irons or the solder bath must be grounded in order to prevent leak voltages generated by them from being applied to the products.
- The products should always be stored and transported in Sanken shipping containers or conductive containers, or be wrapped in aluminum foil.

PWM Off-Line Switching Regulator ICs

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